AOI [1] Advanced Manufacturing of Ceramic Anchors with Embedded Sensors for Process and Health Monitoring of Coal Boilers

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2022 Crosscutting Research and Advanced Energy Systems Project Review Meeting SENSORS & CONTROLS PROGRAM May 4, 2022 (1:00 pm)

Contract DE-FE0031825

Initial Acknowledgments:

Acknowledgment: "This material is based upon work supported by the Department of Energy Award Number DE-FE0031825"

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Background:

- Large volume of ceramic refractory goes into the various boilers
 - Boiler floors and walls stand out as locations that contribute the most to refractory maintenance cost.
 - Less critical are ash hoppers and refractory failure there

 Picture provided by HWI

 Figure provided by

- Understanding <u>thickness loss and degree of thermal shock</u> would be very important in these areas for precise operational planning and refractory replacement.
- Monitoring of <u>crack propagation and stress/strain development</u> during dry-out of the monolithic liner; this process would also be important for the application of these sensor systems.



Program Objectives:

The specific project objectives are as follows:

1) Define high-temperature, stable conductive ceramics to be embedded within refractory anchors; **(Task 2)**

2) Develop and implement the 3D printing technology to pattern and control the microstructure of the ceramic anchor and embedded sensor circuits; **(Task 3)**

3) Develop low power analog electronics and wireless communication hardware to efficiently collect the sensor signal at each processing unit and transmit data to a central hub for data analysis; **(Task 5)**

4) Demonstrate the smart ceramic anchor system for temperature and liner fracture within a boiler furnace simulated environment (which includes better interconnection strategy). (Task 4 & 6)





Publications/Presentations:

Publications

- 1) Coaxial Ceramic Direct Ink Writing on Heterogenous and Rough Surfaces: Investigation of Core-Shell Interactions. ACS Appl. Mater. Interfaces. 2022
- 2) The effect of multivalent elemental doping concentration on crystalline structure and electrical conductivity of lanthanum chromite perovskites obtained by Pechini Sol Gel method. ACS Appl. Mater. Interfaces. 2022
- 3) Theoretical and experimental analysis of dopant concentration and atmosphere nature effects on electrical properties and defect chemistry of doped lanthanum chromite pervoskites. Journal of Alloys and Compounds. 2022.

Presentations

- J.A. Mena, K. Sabolsky, A.A. Abrahamian, D.T. Cipollone, K. Sierros, E. M. Sabolsky, V. Mendoza-Estrada^{2,}, " High Temperature Thick Film Sensors Based on Doped Lanthanum Chromite Refractory Semiconductor Materials," Oral presentation ICMSN 2022 (2022 The 6th International Conference on Materials Sciences and Nanomaterials), July 10-142022.
- 2) D. Cipollone, J.A. Mena, K. Sierros, and E.M Sabolsky, "Out of the Lab: 3D Printing on Non-Ideal Surfaces." Oral presentation at the Materials Science & Technology 2021 (MS&T'21) Virtual Meeting, October 17-20, 2021.
- 3) J. A. Mena, K. Sabolsky, E.M Sabolsky, K. Sierros and K. S. Varadharajan, "Electrical, Structural and Thermomechanical Properties of Doped-LaCrO₃ Ceramics for High Temperature Electronics and Sensing Applications," Oral presentation at the Materials Science & Technology 2021 (MS&T'21) Virtual Meeting, October 17-20, 2021.
- 4) Z. Yang, J. A. Mena, J. Conte, B. Jordan, K. Sabolsky, K. A. Sierros, and E. M. Sabolsky, "Characterization and High Temperature Electrical Properties of Brazed Joints of La_{0.8}Sr_{0.2}CrO₃ with Nickel and Nickel Alloys." Oral presentation at the Materials Science & Technology 2021 (MS&T'21) Virtual Meeting, October 17-20, 2021.
- 5) J.A. Mena, K.V. Sivaneri, G.A. Yakaboylu, E.M. Sabolsky, K. Sabolsky, and K. Sierros, "Evaluation of Doped-LaCrO₃ Ceramics for High Temperature Sensor Applications", Oral presentation at the Materials Science & Technology 2020 (MS&T'20) Virtual Meeting, November 2-6, 2020.



SUMMARY of TECHNICAL TASKS and MILESTONES





Task 2.0 – Fabrication and Characterization of Conductive Ceramic Composites (Sabolsky)





Task 2.0 – Fabrication and Characterization of the Conductive Ceramic Composites

Subtask 2.1- Synthesis and Thermal Processing of Perovskites and Composites

- The conductive oxide composites will be synthesized in-house.
- Thermal processing in an atmosphere (e.g. air, argon) will be completed at high temperatures (up to 1500°C).

• Subtask 2.2- Materials Characterization and Testing

- Characterize initial powder and monoliths using SEM, XRD, XPS and TGA.
- Characterize stability in various environment, non-isothermal, isothermal and cyclic oxidation experiments will be conducted using a high temperature thermogravimetric analyzer (TGA) in an oxidizing gas flow (e.g. ambient air) at various temperatures
- Electrical conductivity of the materials will be measured in a broad temperature range up to 1500°C to understand their electrical performance.



Initial High-Temperature Conductor for Sensors: Doped Lanthanum Chromites :

- > High melting point (~2500 °C).
- Chemical stability under oxidative and reducing atmospheres.
- Pure LaCrO₃ shows semiconducting behavior with no ionic conduction.
- \succ σ = 10 − 200 S·cm-1 (RT − 1500°C).
- Compatibility (thermal expansion coefficients matching) near refractory materials (~10×10⁻⁶ C⁻¹).



A atom cubic unit cell

B atom cubic unit cell





Doped Lanthanum Chromites XRD Characterization:



X-ray diffractograms for the samples of the La_{1-x}Ca_xCrO₃ series Lattice parameters, unit cell volume and XRD theoretical density for doped lanthanum chromites perovskites

	Lattice parameters (Å)			Volume	pXRD _{Theoretical}
Composition	a	с	b	(Å ³)	(g/cm ³)
La _{0.9} Sr _{0.1} CrO ₃	5.5 <mark>124</mark>	7.7926	5.5668	239.1299	6.0658
La _{0.8} Sr _{0.2} CrO ₃	5.4988	7.7853	5.5425	237.2747	6.2568
La _{0.7} Sr _{0.3} CrO ₃	5.4769	7.7580	5.52 <mark>33</mark>	234.6839	6.4710
La _{0.6} Sr _{0.4} CrO ₃	5.4524	7.7407	5.5 <mark>122</mark>	232.6441	6.6721
La _{0.9} Ca _{0.1} CrO ₃	5.4180	7.7332	5.5039	230.6050	6.5962
La _{0.8} Ca _{0.2} CrO ₃	5.4092	7.7264	5.4982	229.7898	6.3340
La _{0.7} Ca _{0.3} CrO ₃	5.3994	7.7058	5.4877	228.3264	6.0871
La _{0.6} Ca _{0.4} CrO ₃	5 <mark>.3897</mark>	7.6853	5.4622	226.2520	5.8528
La _{0.8} Sr _{0.20} Cr _{0.90} Mn _{0.10} O ₃	5. <mark>4734</mark>	7.7765	5.5648	236.8595	6.4197
$La_{0.8}Sr_{0.20}Cr_{0.80}Mn_{0.20}O_3$	5.4705	7.7702	5.5587	236.2829	6.4437
La_0.8Sr_0.20 Cr_0.70Mn_0.30O3	5.4598	7.7498	5.5 <mark>398</mark>	234.4020	6.5037
$La_{0.8}Sr_{0.20}Cr_{0.60}Mn_{0.40}O_3$	5.4146	7.7065	5.4981	229.4225	<mark>6.6</mark> 534

- Decrease in lattice parameters were observed when dopant cations is introduced in the lattice.
- To achieve neutrality chromium oxidation states, change from Cr⁺³ to Cr⁺⁴, reduction in the chromium ionic size occurs.

Doped Lanthanum Chromites Microstructural Characterization:



WVUSRF 5.0kV 12.0mm x4.50k SE(M) 8/31/2021 10.





Average grain size and bulk density distribution for

La_{1-x}Sr_xCrO₃, La_{1-x}Ca_xCrO₃, La_{1-x}Sr_xCr_{1-y}Mn_yO₃ series

Composition	Average grain length (µm)	Relative Percentage Bulk Density (%)
La _{0.9} Sr _{0.1} CrO ₃	3.6480	94
La _{0.8} Sr _{0.2} CrO ₃	3.4898	95
La _{0.7} Sr _{0.3} CrO ₃	3.6290	95
La _{0.6} Sr _{0.4} CrO ₃	3.2455	94
La _{0.9} Ca _{0.1} CrO ₃	4.1367	96
La _{0.8} Ca _{0.2} CrO ₃	3.7727	97
La _{0.7} Ca _{0.3} CrO ₃	3.6883	97
La _{0.6} Ca _{0.4} CrO ₃	3.6548	98
La _{0.8} Sr _{0.20} Cr _{0.90} Mn _{0.10} O ₃	3.3257	95
La _{0.8} Sr _{0.20} Cr _{0.80} Mn _{0.20} O ₃	3.5142	96
La _{0.8} Sr _{0.20} Cr _{0.70} Mn _{0.30} O ₃	3.4771	95
La _{0.8} Sr _{0.20} Cr _{0.60} Mn _{0.40} O ₃	3.3782	97

- Pechini Sol Gel prepared calcium, strontium, manganese doped lanthanum chromite powders exhibit better sinterability and densification under oxidizing conditions.
- The samples of Ca doped lanthanum chromite powder have more dense microstructures.

Doped Lanthanum Chromites Electrical Characterization:

Electrical conductivity dependence of oxygen partial pressures at different temperatures for calcium doped lanthanum chromites



- When the oxygen partial pressure goes below a critical value, the oxygen vacancies are generated at expense of electron holes and conductivity decrease for all compositions.
- At lower temperatures (600°C 900°C) not significant change in conductivity occurs during the equilibrium time used (90 minutes).
- At higher temperatures (1200°C and 1500°C) the conductivity drops exponentially at lower oxygen partial pressures. Increasing the strontium concentration, the conductivity drop significantly.



Doped Lanthanum Chromites Optical and Defect Chemistry Characterization:



High resolution XPS spectra of Ca^{+2} , La^{+3} , O^{-2} , Cr^{+3} , Cr^{+4} and Cr^{+6} in pure calcium doped lanthanum chromite.

- The peak in 576 eV correspond to chromium 2p state associated to the presence of Cr⁺³ and Cr⁺⁴ as expected.
- The formation of chromium higher oxidation states due calcium doping evidence the electron/ polaron hopping as electrical
 conductivity mechanism.

Optical band gap for La_{1-x}Sr_xCrO₃; Ca_{1-x}Sr_xCrO₃; La_{0.8}Sr_{0.2}Cr_{1-y}Mn_yO₃ compositions

Composition	Band Gap (eV)
$La_{0.9}Sr_{0.1}CrO_3$	2.03
La _{0.8} Sr _{0.2} CrO ₃	1.86
La _{0.7} Sr _{0.3} CrO ₃	1.63
La _{0.6} Sr _{0.4} CrO ₃	1.55
La _{0.9} Ca _{0.1} CrO ₃	2.06
$La_{0.8}Ca_{0.2}CrO_3$	1.97
La _{0.7} Ca _{0.3} CrO ₃	1.59
La _{0.6} Ca _{0.4} CrO ₃	1.42
La _{0.8} Sr _{0.2} Cr _{0.9} Mn _{0.1} O ₃	2.03
La _{0.8} Sr _{0.2} Cr _{0.8} Mn _{0.2} O ₃	1.82
$La_{0.8}Sr_{0.2}Cr_{0.7}Mn_{0.3}O_3$	1.62
$La_{0.8}Sr_{0.2}Cr_{0.6}Mn_{0.4}O_3$	1.72

- Band gap values decrease at function of doping level for calcium and strontium content.
- The introduction of strontium and calcium increment the positive holes concentration forming shifts in the conduction bands.

Doped Lanthanum Chromites/ Alumina Composites Characterization :





icture of LCC/ Alumina composites pellets

- Decreasing conductivity effect can be explained by low sinterability of composites with the alumina increment.
- Alumina aggregates affect the LCC grain grow and pore formation increasing the resistance inside the composite.



Ceramic-Based High-Temp Thermocouples (Provisional Patent Application Submitted):



- > The thermoelectric voltage is direct proportionally correlated with temperature difference.
- The thermoelectric testing was completed up to 1500°C; the conductivity and microstructural stability was proven for these materials at higher temperatures.
- Thermocouples were tested in a range between 30 to 1500°C, showing an excellent reproducibility indicating that chromium evaporation has little effects on the device sensitivity.



Task 2 Summary:

Completed Work

- Doped chromites perovskites characterized by XRD, SEM, XPS, UV-Vis and Archimedean density.
- Electrical conductivity testing of all prepared doped lanthanum chromite compositions at temperatures up 1500°C under air, reducing and different oxygen partial pressures atmospheres.
- Optimal compositions passed to Task 3 for embedding in smart refractory.
- New all-ceramic refractory thermocouples invented and implemented into alternative refractory brick (US Patent applied).

Future Work

- Test embedded thermocouples versus cycling and long-term operation at high temperature.
- Investigate alternative n-type ceramic compositions for further development of thermocouples and strain sensor materials.





Task 3.0 – Direct-Writing of Refractory and Sensor System (Sierros)





Task 3.0 – Direct-Writing (2D/3D Patterning) of Refractory and Sensor System

Subtask 3.1- Direct-Writing Ink Development

- Ink formulations will be fabricated within a permissible surface tension and viscosity range for direct-writing.
- Characterization of drying behavior of printed lines at room/moderate temperature. Ink formulations will be characterized using thermogravimetric analysis to understand organics decomposition.

• Subtask 3.2 Direct-Writing/Patterning and Drying Characterization

- Direct writing deposition, drying, and thermal post-processing will be defined, which includes methods to control wetting and drying characteristics of the deposited composite solutions (for both refractory and sensor circuit formulations).
- Ink formulations, direct writing parameters (printing nozzle shape and size, writing speed, extrusion pressure), drying procedures, and post-processing temperatures will be included as variables, and printing fidelity will be characterized by optical, SEM and AFM microscopy.



Task 3.0 – Direct-Writing (2D/3D Patterning) of Refractory and Sensor System

- Subtask 3.3- Thermal Processing Development and Structure Tailoring
 - Post-processing thermal treatment as defined by thermal schedules in Task 2.0.
 - Printed samples will be analyzed by optical microscopy and SEM/EDS as a function of thermal processing (in the bulk and film printed states). The propagation of defects and sintering mismatch, as well as shrinkage, will be studied and analyzed for each layer.

• Subtask 3.4-Baseline Sensor Testing and Design Optimization

- Three (3) initial sensor configurations will be designed using CAD. Electroceramic patterns will be directly written from CAD onto ceramic preforms and directly onto refractory anchor substrates, respectively.
- Feature sizes will be measured by surface profilometry and optical microscopy. After post-processing, electrical performance characterization will be conducted at high-temperatures, ranging from 500-1500°C, in varying atmospheres. Baseline electrical performance will be assessed, and optimized designs will be completed and compared in Task 5.



Direct Ink Writing:

- ➤ Traditionally layer-by-layer
- Adequate for most applications
- ➤ Time to dry increases manufacturing time
- Surface protrusions may induce discontinuities



Coaxial DIW and Platform Preparation:

Can we simplify the manufacturing process through materials engineering?

- Co-extrusion of core-shell ink systems
- ➤ Hydrophilic alumina shell
- ➤ Hydrophobic conductive core
 - Facilitate core fidelity
 - Microfluidic co-flow inspired analyses





Ink Engineering and Flow Analysis:



- NaOH addition enables tailoring ink stiffness one order of magnitude
- Flow stability characterized through mappings of We, Ca, Flow rate ratios, and viscosity ratios





Smart Refractory and Coaxial Printing:







- Alumina barrier maintains core continuity across rough substrate
- Hydrophobic-hydrophilic ink suite maintains interface
 - Sharp transition shown in EDX scan



Future Work:

- Expand direct ink written sensor suite
 Thermistors, thermocouples, and strain sensing elements
 Study microstructure-performance relationships
- Further develop coaxial ceramic DIW technology
 Study of viscous co-flow and stable flow regimes
 Potential to harness deformations and instabilities





Summary and Completed Milestones:

Subtask	Milestone	Planned Completion	Actual Completion
3.1	Ink Formulation	08/31/2020	08/27/2020
3.2	Ink Characterization	08/31/2020	08/31/2020
3.3	Printing of Preforms (2 designs)	12/31/2020	11/04/2020 03/15/2022
3.4	3D Printing of Sensor During Refractory Fab.	10/31/2021	03/25/2021 03/25/2022
6.1	Delivery and Setup of 3D Printer at HWI	06/30/2021	03/25/2021 03/25/2022





Task 4.0 – Development of Embedded Interconnection Design and Smart Anchor Testing (Sabolsky)





Task 4.0 – Development of Embedded Interconnection Design and Smart Anchor Testing

- Subtask 4.1- Anchor Clamp Interconnection Development
 - Ceramic/metal brazes will be evaluated to connect the electroceramic embedded sensor to an insulated metal wire/spring that will pass through the anchor clamp.
 - The electrical (and chemical) stability of the connection will be evaluated as a function of time/temperature to insure a stable interconnection to the electronics.
- Subtask 4.2- Corrosion Testing of Smart Anchor Prototypes
 - Prototype ceramic anchors will be fabricated and tested within static slag conditions at 900-1350°C extending over 24-500 hours.
 - Interconnect clamps designed and fabricated in Subtask 4.1 will be electrically connected to the prototype anchors.
 - The anchors will undergo static slag exposure within the refractory testing system already available to test sensored refractory brick.



Subtask 4.3- Quality Control Testing of Prototype Smart Anchor Samples

- The Recipient will measure the modulus of rupture (MOR) and cold crushing strength (CCS) (after drying and firing) using ASTM C-133.
- Other important characteristics that will be measured will be followed in order qualify the anchors for potential service.
 - Bulk density (by ASTM C-134)
 - Linear change (by ASTM C-113)
 - ➤ Abrasive change (by ASTM C-704).
- Post-mortem microstructure will be evaluated by SEM for the tested prototypes.

Smart Anchors with Slag Insertion Ports Available





Sensor Interconnection by Ag-based Cement:

- Embedded sensors require strong ceramic/metal ohmic joints to interconnect the sensor to the electronics (through an insulated wire).
- Ag-based high temperature conductive and ceramic-metal cements have been identified for mechanical ceramic/metal joints.

Pyro-duct 597-A (Aremco)

- Silver-filled, electrically and thermally conductive adhesive up to 927°C
- Simple application: air dry 1-4 hrs; cure at 100°C for at least 1 hr
- Connects leads to sensor material

Resistance

0.4

0.35

0.3 (suųo)

Resistance (0

0.1

0.05

i 100

Temperature

400

1 2 3 4 5 6 7

Ceramabond 668 (Aremco)

- High temperature adhesive up to 1371°C
- Bonds and seals ceramics to ceramics and ceramics to metals
- Connects and secures wires to the brick

Initial burn-in required for stability

4-pt Resistance Samples 600 Resistance Temperature 5 500 500 -Al₂O₃ substrate 4 (smho) 400 400 -Ag adhesive Û £ au Ag wire 300 300 4-p. 200 200 Silver ribbon 100 1 100 50 LSC Pellet Ag Adhesive 21 22 23 24 25 26 27 28 1 13 18 133 8 37 61 85 109 Time (hrs) Time (hrs) Silver ribbon

Long term stability with LSC

Gen0: Braze vs. Ag-based cement

Full size anchor w/ hole and Gen0: CompA



- Ag-based cement provides results comparable to brazed leads
- Ag-based cement allows for faster and easier application and preparation of bricks for testing



Gen1 and Gen2 Sensor Testing:





Quality Control Testing of Protypes (Go-NoGo):

Demonstrate smart anchor prototype which achieves >75% quality control standards for high-alumina ceramic anchor composition (Modulus of Rupture, Cold Crushing Strength)

Test Type	Criteria	Tested Results
Density after drying, UNITS: pcf		184-188
Using ASTM C-133 MOR after drying, UNITS: psi	>1125	2980-3200
Using ASTM C-133 CCS after drying, UNITS: psi	>6000	11650-16270
Density after 1500F (firing), UNITS: pcf		178-181
Using ASTM C-133 MOR after 1500F firing, UNITS: psi	>375	2080-2430
Using ASTM C-133 CCS after 1500F firing, UNITS: psi	>5250	10650-15010

Samples are quite robust with embedded sensors and achieved >200% of the minimum criteria set for smart anchors at that point.



Task 5 Summary:

Completed Work

> Evaluated castable Ag/refractory composite potting compositions to bond interconnect wires to embedded sensor design.

- ➤ Results show conductive composites show higher stability and strength over brazed leads (and easier thermal processing methodology).
- ➢Quality control testing (MOR and CCS testing) showed that the smart anchors are comparable to current anchor products.

Future Work

➤Complete evaluation of Gen3 sensors with lower temperature cold end connection.

≻Complete in-house corrosion testing.

➢ Initiate testing of thermocouple sensors.

> Develop engineering method to secure connection for deployment in a commercial application (discussed further in Task 6).



Task 5.0 – Electronics and Wireless Communication Interfacing with Smart Ceramic Anchors (Graham)





Task 5 Objectives:

- To develop methods to interface the electrical sensing outputs from the smart refractory with an embedded processor
- To design a wireless sensor network to efficiently collect the data at a processing unit for further data analysis



Task 5.0 – Electronics and Wireless Communication Interfacing with Smart Ceramic Anchors

• Subtask 5.1- Interfacing Electrical Outputs to Motes

- Initial interface circuitry will be designed using discrete off-the-shelf components to obtain a working system and to allow for full system integration.
- These interface circuits will be used for monitoring the sensors within the ceramic anchors and providing the appropriate signals to the wireless embedded processor.

Subtask 5.2- Wireless Data Transport and Stand-alone Performance Evaluation with Simulated Electrical Signals

- The aim of this subtask will be to reliably transport the anchor sensing data from the individual motes to a
 data processing center over a wireless communication medium, and to allow convenient wireless
 configuration of sensor parameters from a remote processing center.
- Initial sensor network prototype will be developed to evaluate in a stand-alone mode using simulated sensor data. The information delivery performance will be evaluated for the typical ceramic anchor application-parameters including data sampling requirements, sensor density, and number of sensors.

• Subtask 5.3- Investigating Reconfigurable Integrated Circuits Interfaces

- Reconfigurable IC solutions are a natural choice for this application because of the iterative nature of testing and the capability to refine performance after final deployment.
- Further implication of this design choice is the ability to reconfigure the sensing circuitry wirelessly when
 interfaced with the motes, whether the circuitry is in-the-field or in a lab setting.
- The reconfigurable ICs will interface the motes and anchor sensors in the same manner as the off-the-shelf sensing circuits without any needed modifications to the mote.



Task 5.0 Sensor Interfacing Circuitry

Discrete Sensor-Interfacing Circuits







Custom Integrated Circuits



- 1. Cold-Junction Compensator
- 2. Thermocouple Amplifier
- 3. Capacitive Sensor
- 4. Thermocouple Amplifier V2
- 5. Wheat-Stone Bridge

Reconfigurable Integrated Circuits



Flexibility post-deployment Ultra-low power implementations



Task 5.0 Prototype and Test Run Results

- Arduino Nano 33 IoT
 - Includes low energy Bluetooth (BLE)
 - Analog-to-Digital (ADC) converter for digitizing input data from WSB
- Test runs resulted with accurate received readings (resistance) from the wireless node
- Auto-ranging functionality to improve measurement resolution





Task 5.0 System and Software Improvements

Voltage vs. Time

3.0

2.5

/oltage (V) 1.5

1.0

0.5

- Python User Interface
 - Library for reading serial interface on Nano 33 IoT
 - Handles auto-ranging & BLE communication
 - of measurements



Task 5 Summary:

Completed Work

- Built prototype sensor interfacing circuit/platform
- Implemented better microcontroller/radio platform
- Developed Python software infrastructure for data collection and analysis
- Implemented auto ranging functionality on the sensor circuitry for accommodating a larger range of resistance/temperatures
- Milestone 8 Completed Demonstrate operational prototype of sensor interfacing electronics

Future Work

- Improve the power savings (implement a real-time clock for duty cycling, etc.)
- Expand to thermocouples and other sensors
- Implement a custom solution on our reconfigurable sensor-interfacing and analysis platform



Task 6.0 Ceramic Anchor Manufacturing and Concept Demonstration (Sabolsky)





Task 6.0 Ceramic Anchor Manufacturing and Concept

- Subtask 6.1- Scale-up of Smart Ceramic Anchor Production
 - Fabricate the sensor preforms formed by 2D/3D printing, and begin to design and setup a printing system.
 - Implement trials of ceramic anchor manufacturing. Anchors will undergo quality control analysis, where basic statistics on loss/failure rates may be estimated for Task 7.0.
 - Anchor clamping and wiring trials will be completed to mimic actual monolithic (castable) refractory installation within the primary furnace of a boiler.

Subtask 6.2- Quarterly Ceramic Anchor Testing Trials

- Quarterly testing of anchor and interconnection performance (in a non-critical application), the anchors will be inserted within the available kilns.
- At least three (3) smart prototype anchors will be evaluated each quarter (starting at the onset of this task within the program) using the optimal smart anchor, interconnect clamp and electronics/wireless motes for the current quarter.



Task 6.0 Ceramic Anchor Manufacturing and Concept

Subtask 6.3- End-user In-service Smart Ceramic Anchor Demonstration (DEMO)

- A minimum of three (3) smart anchors will be installed within the liner of a coal boiler, ash hopper, or glass furnace floor.
- The demonstration will include at least three wireless sensor nodes utilizing the optimal electronic interface, power configuration, and wireless network defined in Task 5.0.
- The end-user demonstration customer(s) will be <u>identified</u>
 <u>by quarter eleven</u>.



Smart Anchor with a Silver Sensor Connection:



- Half-sized bricks were cast with printed sensors and cavity to facilitate testing
- Silver adhesive was used to attach sensor to silver leads
- Refractory mortar was applied to protect connections during testing in a commercial setting

Test with Silver Adhesive Connection 500000 1400 Hot TC 1200 400000 1000 (ohms) 300000 800 200000 600 Cold TC 400 100000 200 Resistanc

35

Time (hrs)

45

55

Silver wire leads connection with protective layers

5

15

25







Initial protection



Refractory protection



0

65

Gen 2 Sensor Brick Deployed at HWI:

High Temperature Furnace at HWI

Gen2 Sensor Brick in door installation

Connection to electronics





Connection to electronics



Connection to laptop



On-screen data monitoring



Task 6 Summary:

Completed Work

➢ Full-scale production and testing of smart anchors with all components and installed at HWI Research Center for testing.

- Optimized sensor material system (Gen0, Gen2, and Gen3 sets)
- Low-power sensor electronics with wireless communication installed and testing

Future Work

➤Continue longer-term testing of greater number of sensored anchors for statistics and better understanding of degradation mechanisms.

➢ Discussion with customers on issues for practical installation.

Installation within continuous kiln production facilities within HWI Ohio and/or Kentucky (>1400°C operations for months). Next step for customer assurance of technology.



Acknowledgments:



- Robie Lewis and Maria Reidpath, project managers at U. S. Department of Energy, is greatly appreciated for his insight and valuable guidance.
- We also would like to acknowledge Mr. Harley Hart, Dr. Qiang Wang, and Dr. Marcela Redigolo for their cooperation and valuable assistance in the WVU Shared Facilities.
- Kindly acknowledge faculty and staff of West Virginia University for their support.



Thank you!!!

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Questions

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